| © C  | terial Compositi<br>opyright 2005. IPC, E<br>rnational and Pan-Am                                      | Bannockb          | urn, Illinois. A          | ll rights reserved untions.                        | under both       | This docume<br>level parts, ti                                  | ent is a decl<br>he declarat        | laration | n of the sub<br>compasses  | ostances<br>all lower | within the<br>level mat         | manufactur<br>erials for w      | rer listed i<br>hich the n | tem. N<br>nanufa | lote: if th<br>cturer ha | e item is an as<br>s engineering | sembly with low<br>responsibility. |
|--|--|-------------------|---------------------------|--|------------------|---|-------------------------------------|----------|----------------------------|-----------------------|---------------------------------|---------------------------------|----------------------------|------------------|--------------------------|----------------------------------|------------------------------------|
|  | IPC Web Site for Information on IPC-1752 Standard Form Type '   http://www.ipc.org/IPC-175x Distribute |                   |                           |  | *                | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                                     |          |                            |                       |                                 | ials and Mfg Information        |                            |                  |                          |                                  |                                    |
| Supplier Information                           | l  |                   |                           |  |                  |   |                                     |          |                            |                       |                                 |                                 |                            |                  |                          |                                  |                                    |
| Company name*                                  | Company unique ID  |                   |                           | Unique ID Authority                                |                  |   |                                     |          |                            | Response Date*        |                                 |                                 |                            |                  |                          |                                  |                                    |
| onsemi   |  |                   |                           |  |                  |   |                                     |          |                            | 2024-04               | 2024-04-19                      |                                 |                            |                  |                          |                                  |                                    |
| Contact Name                                   | Title - Contact  |                   |                           | ]  | Phone - Contact* |   |                                     |          |                            | Email - Contact*      |                                 |                                 |                            |                  |                          |                                  |                                    |
| Product-Env-Stewards                           |  |                   | Product Enviro Compliance |  |                  |   | NA                                  |          |                            |                       |                                 | Product-Env-Stewards@onsemi.com |                            |                  |                          |                                  |                                    |
| Authorized Representative*                     |  |                   | Title - Representative    |  |                  | Phone - Representative*   |                                     |          |                            |                       | Email - Representative*         |                                 |                            |                  |                          |                                  |                                    |
| Product-Env-Stewards                           |  |                   | Product Enviro Compliance |  |                  | NA  |                                     |          |                            |                       | Product-Env-Stewards@onsemi.com |                                 |                            |                  |                          |                                  |                                    |
| Requester Item                                 | Requester Item Number Mfr Item Number   Image: NCP1618CDR2G  |                   | n Number Mfr Item Name    |  |                  |   | Effective Date Version   2024-04-19 |          | Version                    | N                     | Manufacturing Site              |                                 | ,                          | Weigh            | ıt*                      | UOM                              | Unit Type                          |
|  |  |                   |                           | NCP1618C (multi mode) PFC (metal tweak<br>NCP1618) |                  |   |                                     |          | F                          | PH1                   |                                 | ,                               | 74.52                      |                  | mg                       | Each                             |                                    |
| Manufacturing Proce                            | cess Information   |                   |                           |  |                  |   |                                     |          |                            |                       |                                 |                                 |                            |                  |                          |                                  |                                    |
| Terminal Plating / Grid Array Material         |  | 1 Te              | erminal Base A            | minal Base Alloy J-STD-020                         |                  | Rating  | Peak                                | Proces   | ocess Body Temperature Max |                       | e Max T                         | ax Time at Peak Tempera         |                            | ure 1            | Number                   | of Reflow Cyc                    | les                                |
| Precious metal (e.g. Ag,Au, NiPdAu) (no<br>Sn) |  | ) (no C           | U Alloy 1                 |  | 1                |   | 260                                 |          | С                          |                       | 30                              |                                 | seconds 3                  |                  | 3                        |                                  |                                    |
| Comments                                       |  |                   |                           |  |                  |   |                                     |          |                            |                       |                                 |                                 |                            |                  |                          |                                  |                                    |
| evel 1 - maximum time at                       | peak temperature d   | uring sol         | dering is 10-3            | 0 seconds  |                  |   |                                     |          |                            |                       |                                 |                                 |                            |                  |                          |                                  |                                    |
| or more information rega                       | arding material com  | position <b>p</b> | please refer to           | page 3   |                  |   |                                     |          |                            |                       |                                 |                                 |                            |                  |                          |                                  |                                    |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | ances per the definitio  | on above  | Supplier Acceptance                             | * Accepted  |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance  | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|--|------------------|--------|---------|-----------------|
| Die                  | 1.26   | mg              | Supplier | Silicon (Si)   | 7440-21-3        |        | 1.26    | mg              |
| Die Attach           | 0.37   | mg              | Supplier | Epoxized Condensate Of Para-<br>Hydrobenzaldehyde And Alkyl Phenol | 129915-35-1      |        | 0.074   | mg              |
|                      |        |                 | Supplier | Silver (Ag)  | 7440-22-4        |        | 0.296   | mg              |
| Lead Frame           | 21.32  | mg              | Supplier | Silver (Ag)  | 7440-22-4        |        | 0.3624  | mg              |
|                      |        |                 | Supplier | Zinc (Zn)  | 7440-66-6        |        | 0.0256  | mg              |
|                      |        |                 | Supplier | Iron (Fe)  | 7439-89-6        |        | 0.501   | mg              |
|                      |        |                 | Supplier | Copper (Cu)  | 7440-50-8        |        | 20.4246 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)   | 7723-14-0        |        | 0.0064  | mg              |
| Mold Compound-Black  | 50.28  | mg              |          | Epoxy resin  | proprietary data |        | 2.514   | mg              |
|                      |        |                 | Supplier | Phenolic Resin   | Proprietary Data |        | 1.0056  | mg              |
|                      |        |                 | Supplier | Ortho Cresol Novolac Resin   | 29690-82-2       |        | 1.257   | mg              |
|                      |        |                 | Supplier | Carbon Black (C)   | 1333-86-4        |        | 0.2514  | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)  | 60676-86-0       |        | 45.252  | mg              |
| Plating              | 1.14   | mg              | Supplier | Palladium (Pd)   | 7440-05-3        |        | 0.0798  | mg              |
|                      |        |                 | В        | Nickel (Ni)  | 7440-02-0        |        | 1.0374  | mg              |
|                      |        |                 | Supplier | Gold (Au)  | 7440-57-5        |        | 0.0228  | mg              |
| Wire Bond - Au       | 0.15   | mg              | Supplier | Gold (Au)  | 7440-57-5        |        | 0.15    | mg              |